METECH INTERNATIONAL LIMITED
(Incorporated in the Republic of Singapore)
(Company Registration Number 199206445M)

PROPOSED PLACEMENT OF 100,000,000 NEW ORDINARY SHARES (THE "PLACEMENT SHARES") IN THE CAPITAL OF METECH INTERNATIONAL LIMITED (THE "PLACEMENT")

- COMPLETION OF THE PLACEMENT

The Board of Directors (the "**Board**") of Metech International Limited (the "**Company**") refers to its respective announcements dated 26 June 2026, 4 July 2026, 12 July 2026, 13 July 2026, 16 July 2026, 23 July 2026 and 28 July 2026 in relation to the Placement (collectively, the "**Previous Announcements**").

Unless otherwise defined, all capitalised terms used in this announcement shall bear the same meanings ascribed to them in the Previous Announcements.

COMPLETION OF THE PLACEMENT

The Board wishes to announce that the Company has, on 30 July 2026, allotted and issued 22,000,000 Placement Shares to Raffles Capital Limited ("**RCL**") pursuant to the terms and conditions of the subscription agreement entered into with RCL, as supplemented (the "**Subscription Agreement**").

Following the allotment and issuance of the 22,000,000 Placement Shares, the number of ordinary shares in the capital of the Company (the "**Shares**") has increased from 313,510,200 Shares to 335,510,200 Shares.

The 22,000,000 Placement Shares are free from all claims, pledges, mortgages, charges, lien and encumbrance and rank *pari passu* in respect of the existing Shares, except that the 22,000,000 Placement Shares do not rank for any dividends, rights, allotments or other distributions, the record date for which falls on or before the date of the issue of the 22,000,000 Placement Shares.

As announced by the Company on 13 July 2026, the Company had, allotted and issued 50,000,000 Placement Shares to Mr. Ma Ong Kee ("**Mr. Ma**") pursuant to the terms and conditions of the Subscription Agreement entered into with Mr. Ma. The 50,000,000 Placement Shares that were issued are free from all claims, pledges, mortgages, charges, lien and encumbrance and rank *pari passu* in respect of the existing Shares, except that the 50,000,000 Placement Shares do not rank for any dividends, rights, allotments or other distributions, the record date for which falls on or before the date of the issue of the 50,000,000 Placement Shares. As disclosed in the Company's announcement dated 16 July 2026, the 50,000,000 Placement Shares had not been credited to Mr. Ma, and as such, such Placement Shares had not been listed and quoted on the Catalist of the SGX-ST.

As announced by the Company on 28 July 2026, the Company had received the LQN from the SGX-ST for the listing and quotation of the 72,000,000 Placement Shares at an issue price of S$0.040 per Placement Share. The LQN issued by the SGX-ST is not to be taken as an indication of the merits of the Placement, the Placement Shares, the Company, its subsidiaries or its securities.

The 72,000,000 Placement Shares are expected to be listed and quoted on the Catalist of the SGX-ST on or about 4 August 2026 and the trading of the 72,000,000 Placement Shares is expected to commence from 9.00 a.m. on the same date.

FURTHER ANNOUNCEMENTS

The Company will make further announcement(s) to provide updates to shareholders of the Company as and when appropriate, in particular, in relation to the placement of the remaining 28,000,000 Placement Shares to RCL under the terms of the Subscription Agreement.

By Order of the Board of Directors of
Metech International Limited

Pang Wei Hao
Executive Director and Chief Executive Officer

30 July 2026
